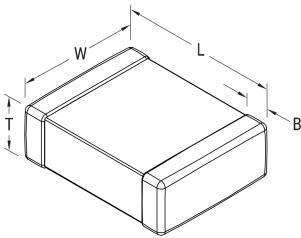


C2225H331KGGAE7130

SMD Indust COG HVHT200C, Ceramic, 330 pF, 10%, 2000 VDC, COG, SMD, MLCC, High Temperature, Ultra-Stable, Low Loss, 2225



Click	here	for	the	3D	model.

Dimensions		,
Chip Size	2225	
L	5.6mm +/-0.4mm	
W	6.4mm +/-0.4mm	
T	1.4mm +/-0.15mm	
В	0.6mm +/-0.35mm	

Packaging Specifications			
Packaging	T&R, 180mm, Plastic Tape		
Packaging Quantity	1000		

General Information	
Series	SMD Indust COG HVHT200C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable, Low Loss
Features	High Temp, Ultra-Stable, Low Loss
RoHS	Yes
Termination	Gold
Marking	No
AEC-Q200	No
Component Weight	300 mg
Miscellaneous	Moisture Sensitive Packaging. Gold (Au) 1.97 - 11.8 micro inches.
Shelf Life	26 Weeks
MSL	1

Specifications	
Capacitance	330 pF
Measurement Condition	1 MHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	2000 VDC
Dielectric Withstanding Voltage	2400 VDC
Temperature Range	-55/+200°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

单击下面可查看定价,库存,交付和生命周期等信息

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